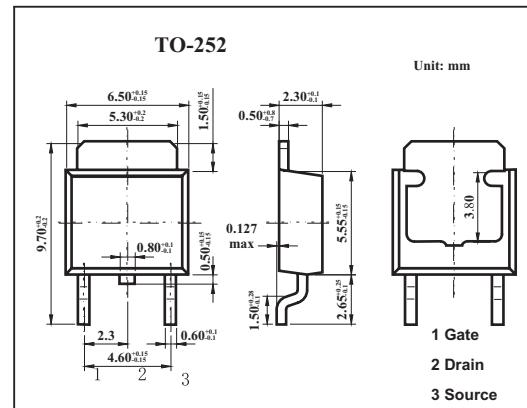


MOS Field Effect Transistor

2SK3386

■ Features

- Low on-resistance
 $R_{DS(on)1} = 21 \text{ m}\Omega \text{ MAX. } (V_{GS} = 10 \text{ V}, I_D = 17\text{A})$
 $R_{DS(on)2} = 36 \text{ m}\Omega \text{ MAX. } (V_{GS} = 4.0 \text{ V}, I_D = 17\text{A})$
- Low C_{iss} : C_{iss} = 2100 pF TYP.
- Built-in gate protection diode



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	±30	A
	I _{Dp} *	±100	A
Power dissipation T _c =25°C T _A =25°C	P _D	36	W
		1.0	
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

* PW≤10 μ s,Duty Cycle≤1%

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain cut-off current	I _{DSS}	V _{Ds} =60V,V _{GS} =0			10	μ A
Gate leakage current	I _{GSS}	V _{GS} =±20V,V _{Ds} =0			±10	μ A
Gat cutoff voltage	V _{GS(off)}	V _{Ds} =10V,I _D =1mA	1.5	2.0	2.5	V
Forward transfer admittance	Y _{fs}	V _{Ds} =10V,I _D =17A	10	19		S
Drain to source on-state resistance	R _{DS(on)1}	V _{GS} =10V,I _D =17A		17	21	mΩ
	R _{DS(on)2}	V _{GS} =4.0V,I _D =17A		25	36	mΩ
Input capacitance	C _{iss}	V _{Ds} =10V,V _{GS} =0,f=1MHZ		2100		pF
Output capacitance	C _{oss}			340		pF
Reverse transfer capacitance	C _{rss}			170		pF
Turn-on delay time	t _{on}	I _D =17A,V _{GS(on)} =10V,R _G =10Ω,V _{DD} =30V		32		ns
Rise time	t _r			310		ns
Turn-off delay time	t _{off}			98		ns
Fall time	t _f			100		ns
Total Gate Charge	Q _G	I _D =34A, V _{DD} =48 V, V _{GS} =10 V		39		nC
Gate to Source Charge	Q _{GS}			7.0		nC
Gate to Drain Charge	Q _{GD}			12		nC